

# SYSTEM DATA SHEET

# Sikafloor® MultiDur EB-39 ECF

BROADCAST, TOUGH-ELASTIC, UNICOLOUR CONDUCTIVE EPOXY FLOOR COVERING WITH HIGH CHEMICAL RESISTANCE

#### **DESCRIPTION**

Sikafloor® MultiDur EB-39 ECF is a two part, electrostatic conductive, tough-elastic, self-smoothing, broadcast coloured epoxy flooring system with very high chemical resistance. "Total solid epoxy composition acc. to the test method Deutsche Bauchemie e.V. (German Association for construction chemicals)".

#### **USES**

Sikafloor  $^{\rm @}$  MultiDur EB-39 ECF may only be used by experienced professionals.

It is used as:

- Tough elastic, chemically resistant coating for concrete and screed surfaces in bund areas for the protection against water contaminating liquids (according resistance table)
- Electrostatic conductive coating for areas subject to chemical exposure and demands for slip resistance

## **CHARACTERISTICS / ADVANTAGES**

- High chemical resistance
- Mechanical resistance
- Impervious to liquids
- Abrasion resistant
- Slip resistant surface

#### **ENVIRONMENTAL INFORMATION**

- Conforms to AgBB (2012) for use in indoor environment. Test report No. 392-2015-00129301\_02.
   Eurofins Product Testing.
- Conformity with LEED v2009 IEQc 4.2: Low-Emitting Materials - Paints and Coatings

## **APPROVALS / STANDARDS**

- Self-smoothing, coloured epoxy resin coating according to EN 1504-2: 2004 and EN 13813, DoP 02 08 01 02 020 000008 2017, certified by Factory Production Control Body No. 0921, certificate 2017, and provided with the CE-mark
- Outgassing emission certificate Sikafloor®-390 ECF CSM: CSM Statement of Qualification - ISO 14644-8, class -9.6 - Report No. SI 1204-593
- Fire classification in accordance with DIN 4102 part 1 and part 14, Report-No. 130682-2, class B1, Institute Hoch, Germany, June 2013

#### PRODUCT INFORMATION

Packaging	Please refer to individual Product Data Sheet.
Shelf Life	Please refer to individual Product Data Sheet.
torage Conditions Please refer to individual Product Data Sheet.	

# SYSTEM INFORMATION **System Structure** Sikafloor® MultiDur EB-39 ECF: 4 3 2 1 1. Primer + Earthing connection Sikafloor®-161 HC + Sika® Earthing 2. Conductive primer Sikafloor®-220 W Conductive 3. Conductive base coating + broad-Sikafloor®-390 ECF, broadcast to casting excess with silicone carbide 0.5-1.0 4. Final topcoat Sikafloor®-390 + 5 % wt.-% Thinner C The system configurations as described must be fully complied with and may not be changed. Composition Ероху **Appearance** Broadcast - semi gloss Colour Almost unlimited choice of colour shades. Under direct sun radiation there may be some discolouration and colour deviation, this has no influence on the function and performance of the coating. **Nominal Thickness** ~ 2.0 - 2.5 mm **TECHNICAL INFORMATION**

Tensile Strength	~ 10 N/mm²	(14 days / +23 °C)	(DIN 53455)
Electrostatic Behaviour	Resistance to ground <sup>1</sup> Typical average resistance to ground <sup>2</sup>	$-\frac{R_g<10^9~\Omega}{R_g<10^6~\Omega}$	(IEC 61340-4-1) (DIN EN 1081)



 $<sup>^1\,</sup>$  In accordance with IEC 61340-5-1 and ANSI/ESD S20.20.  $^2\,$  Readings may vary, depending on ambient conditions (i.e. temperature, humidity) and measurement equipment.

# **APPLICATION INFORMATION**

Consumption	Coating	Product	Consumption	
	Primer	Sikafloor®-161 HC	1-2 x ~ 0.3 - 0.5 kg/m <sup>2</sup>	
	Levelling (if required)	Sikafloor®-161 HC lev- elling mortar	Refer to PDS of Sika- floor®-161 HC	
	Earthing connection	Sika® Earthing Kit	1 earthing point per approx. 200 -300 m <sup>2</sup> , min. 2 per room.	
	Conductive primer	Sikafloor®-220 W Con- ductive	1 x 0.08 - 0.10 kg/m²	
	Conductive base coating	Sikafloor®-390 ECF, unfilled	1x 1.6 kg/m <sup>2</sup> Binder, broadcast to excess with silicone carbide 0.5-1.0. mm*	
	Final topcoat	Sikafloor®-390 + 5 % Thinner C	0.75 - max. 0.85 kg/m <sup>2</sup>	
	These figures are theoretical and do not allow for any additional material due to surface porosity, surface profile, variations in level or wastage etc.			
	*Silicone carbide "SiC 18/35 in a splintery grain shape and a grain size of 0.5-1.0 mm" can be purchased from ESH-SIC GmbH, Günter-Wiebke-Str. 1, 50226 Frechen, Germany, http://www.esk-sic.com. As altern ative the conductive aggregate "Granucol Conduct No. 7" (grain size 0.6 - 1.2 mm) can be used. Supplier: Gebrüder Dorfner GmbH & Co. Kaolin- und Kristallquarzsand-Werke KG, Scharhof 1, 92242 Hirschau, Germany, http://www.dorfner.com			
Ambient Air Temperature	+10 °C min. / +30 °C ma	ax.		
Relative Air Humidity	80 % r.h. max.			
Dew Point	Beware of condensation! The substrate and uncured floor must be at least 3 °C above dew point to reduce the risk of condensation or blooming on the floor finish.			
	+10 °C min. / +30 °C max.			
Substrate Temperature	+10 °C min. / +30 °C ma	ax.		
	<4 % pbw moisture cor Test method: Sika Tran			
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#### **Applied Product Ready for Use**

Temperature	Foot traffic	Light traffic	Full cure
+10°C	~ 48 hours	~ 6 days	~ 14 days
+20°C	~ 30 hours	~ 4 days	~ 10 days
+30°C	~ 20 hours	~ 3 days	~ 7 days

Note: Times are approximate and will be affected by changing ambient conditions

#### **MAINTENANCE**

#### **CLEANING**

Please refer to the individual Sikafloor® Cleaning Regime.

#### **FURTHER DOCUMENTS**

Please refer to:

- Sika® Method Statement Mixing and Application of Flooring Systems
- Sika® Method Statement Surface Evaluation & Preparation

#### **IMPORTANT CONSIDERATIONS**

- This system may only be used by experienced professionals.
- Due to the nature of carbon fibres providing the conductivity, surface irregularities might be possible.
   This has no influence on the function and performance of the coating.
- Do not apply the Sikafloor® MultiDur EB-39 ECF System on substrates in which significant vapour pressure may occur.
- Do not blind the primer.
- The freshly applied final conductive coating of the Sikafloor® MultiDur EB-39 ECF system must be protected from damp, condensation and water for at least 24 hours.
- Only start application of Sikafloor® conductive primer after the priming coat has dried tack-free all over.
   Otherwise there is a risk of wrinkling or impairing of the conductive properties.
- Maximum layer thickness of final conductive coating:
   1.5 mm. Excessive thickness (more than 2.5 kg/m²) causes reduced conductivity.
- Under certain conditions, underfloor heating combined with high point loading, may lead to imprints in the resin
- If heating is required do not use gas, oil, paraffin or other fossil fuel heaters, these produce large quantities of both CO<sub>2</sub> and H<sub>2</sub>O water vapour, which may adversely affect the finish. For heating use only electric powered warm air blower systems.
- The incorrect assessment and treatment of cracks may lead to a reduced service life and reflective cracking - reducing or breaking conductivity.
- For exact colour matching, ensure the final topcoat of the Sikafloor® MultiDur EB-39 ECF system in each area is applied from the same control batch numbers.
- The test person, ambient conditions, measurement equipment, cleanliness of the floor have a substantial influence on the measurement results.

All measurement values for the Sikafloor® MultiDur

EB-39 ECF system stated in the system data sheet (apart from the ones referring to proof statements) were measured under the following conditions:

Ambient conditions:	+23 °C/50%
Measurement device for	Metriso 2000 (Warmbier)
the Resistance to Ground:	or comparable
Surface resistance probe:	Tripod electrode acc. DIN
	EN 1081
Rubber pad hardness:	Shore A 60 (± 10)

The number of conductivity measurements is strongly recommended to be as shown in the table below:

Ready applied area	Number of measure- ments	
< 10 m <sup>2</sup>	6 measurements	
< 100 m <sup>2</sup>	10-20 measurements	
<1000 m²	50 measurements	
<5000 m <sup>2</sup>	100 measurements	

In case of values lower/higher as required, additional measurements has to be carried out, approx. 30 cm around the point with insufficient readings. If the newly measured values are in accordance with the requirements, the total area is acceptable. Installation of earthing points: Please refer to the Method Statement: "MIXING & APPLICATION OF FLOORING SYSTEMS".

Numbers of earth connections: Per room at least 2 earthing points. The optimum number of earth connections depends on the local conditions and should be specified using available drawings.

## **BASIS OF PRODUCT DATA**

All technical data stated in this Product Data Sheet are based on laboratory tests. Actual measured data may vary due to circumstances beyond our control.



#### **LOCAL RESTRICTIONS**

Please note that as a result of specific local regulations the performance of this product may vary from country to country. Please consult the local Product Data Sheet for the exact description of the application fields.

## **ECOLOGY, HEALTH AND SAFETY**

For information and advice on the safe handling, storage and disposal of chemical products, users shall refer to the most recent Safety Data Sheet (SDS) containing physical, ecological, toxicological and other safety-related data.

#### **LEGAL NOTES**

The information, and, in particular, the recommendations relating to the application and end-use of Sika products, are given in good faith based on Sika's current knowledge and experience of the products when properly stored, handled and applied under normal conditions in accordance with Sika's recommendations. In practice, the differences in materials, substrates and actual site conditions are such that no warranty in respect of merchantability or of fitness for a particular purpose, nor any liability arising out of any legal relationship whatsoever, can be inferred either from this information, or from any written recommendations, or from any other advice offered. The user of the product must test the product's suitability for the intended application and purpose. Sika reserves the right to change the properties of its products. The proprietary rights of third parties must be observed. All orders are accepted subject to our current terms of sale and delivery. Users must always refer to the most recent issue of the local Product Data Sheet for the product concerned, copies of which will be supplied on request.

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